

Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

<u>Texas Instruments</u> <u>SN74BCT2240DBR</u>

For any questions, you can email us directly: sales@integrated-circuit.com

Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN54BCT2240, SN74BCT2240 OCTAL BUFFERS AND LINE/MOS DRIVERS WITH 3-STATE OUTPUTS

SCBS030E - SEPTEMBER 1988 - REVISED MARCH 2003

- Operating Voltage Range of 4.5 V to 5.5 V
- State-of-the-Art BiCMOS Design Significantly Reduces I_{CCZ}
- Output Ports Have Equivalent 33-Ω Series Resistors, So No External Resistors Are Required
- 3-State Outputs Drive Bus Lines or Buffer **Memory Address Registers**

description/ordering information

These octal buffers and line drivers are designed specifically to improve both the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. Together with the SN74BCT2241 and the 'BCT2244 devices, these devices provide the choice of selected combinations of inverting and noninverting outputs, symmetrical active-low output-enable (OE) inputs, and complementary OE and OE inputs. These devices feature high fan-out and improved fan-in.

The 'BCT2240 devices are organized as two 4-bit line drivers with separate output-enable (OE) inputs. When \overline{OE} is low, the device passes data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

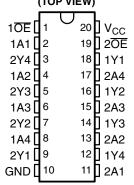
To ensure the high-impedance state during power

up or power down, OE should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of

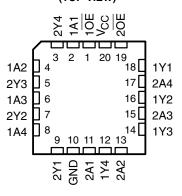
the driver. The outputs, which are designed to source or sink up to 12 mA, include $33-\Omega$ series resistors to reduce overshoot

and undershoot.

SN54BCT2240 . . . J OR W PACKAGE SN74BCT2240 . . . DB, DW, N,OR NS PACKAGE (TOP VIEW)



SN54BCT2240 . . . FK PACKAGE (TOP VIEW)



ORDERING INFORMATION

TA	PACKA	GE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
0°C to 70°C	PDIP – N	Tube	SN74BCT2240N	SN74BCT2240N	
	0010 DW	Tube	SN74BCT2240DW	DOT0040	
	SOIC - DW	Tape and reel	SN74BCT2240DWR	BCT2240	
	SOP – NS Tape and reel		SN74BCT2240NSR	BCT2240	
	SSOP – DB	Tape and reel	SN74BCT2240DBR	BA240	
	CDIP – J Tube		SNJ54BCT2240J	SNJ54BCT2240J	
–55°C to 125°C	CFP – W Tube		SNJ54BCT2240W	SNJ54BCT2240W	
	LCCC - FK	Tube	SNJ54BCT2240FK	SNJ54BCT2240FK	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



POST OFFICE BOX 655303 ● DALLAS, TEXAS 75265 POST OFFICE BOX 1443 ● HOUSTON, TEXAS 77251–1443

1

Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

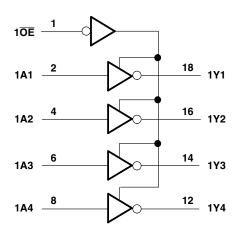
SN54BCT2240, SN74BCT2240 OCTAL BUFFERS AND LINE/MOS DRIVERS WITH 3-STATE OUTPUTS

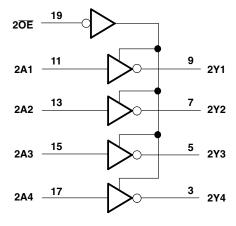
SCBS030E - SEPTEMBER 1988 - REVISED MARCH 2003

FUNCTION TABLE (each buffer)

INP	JTS	OUTPUT
ŌĒ	Α	Υ
L	Н	L
L	L	Н
Н	Χ	Z

logic diagram (positive logic)







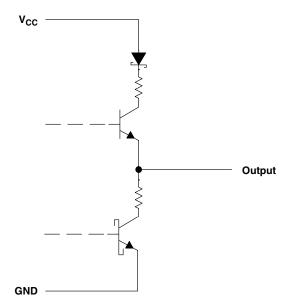


Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN54BCT2240, SN74BCT2240 OCTAL BUFFERS AND LINE/MOS DRIVERS **WITH 3-STATE OUTPUTS** SCBS030E - SEPTEMBER 1988 - REVISED MARCH 2003

schematic of Y outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}		0.5 V to 7 V
Input voltage range, V _I (see Note 1)		0.5 V to 7 V
Voltage range applied to any output in the disal	oled or power-off state, VO	–0.5 V to 5.5 V
Voltage range applied to any output in the high	state, V _O	–0.5 V to V _{CC}
Input clamp current, I _{IK}		–30 mA
Current into any output in the low state		24 mA
Package thermal impedance, θ_{JA} (see Note 2):	DB package	70°C/W
	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.





Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN54BCT2240, SN74BCT2240 OCTAL BUFFERS AND LINE/MOS DRIVERS WITH 3-STATE OUTPUTS

SCBS030E - SEPTEMBER 1988 - REVISED MARCH 2003

recommended operating conditions (see Note 3)

		SN54BCT2240			SN74BCT2240			LINUT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			8.0			0.8	V
I _{IK}	Input clamp current			-18			-18	mA
I _{OH}	High-level output current			-12			-12	mA
I _{OL}	Low-level output current			12			12	mA
T _A	Operating free-air temperature	-55		125	0		70	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		SN	54BCT22	240	SN74BCT2240				
PARAMETER	TE	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT	
V _{IK}	$V_{CC} = 4.5 \text{ V},$	$I_I = -18 \text{ mA}$			-1.2			-1.2	V
V	V 45V	$I_{OH} = -1 \text{ mA}$	2.4	3.3		2.4	3.3		V
V _{OH}	$V_{CC} = 4.5 \text{ V}$	$I_{OH} = -12 \text{ mA}$	2	3.2		2	3.2		V
V	V 45V	I _{OL} = 1 mA		0.15	0.5		0.15	0.5	V
V _{OL}	V _{CC} = 4.5 V	$I_{OL} = 12 \text{ mA}$		0.35	0.8		0.35	8.0	V
I _I	$V_{CC} = 5.5 \text{ V},$	$V_I = 7 V$			0.1			0.1	mA
I _{IH}	$V_{CC} = 5.5 \text{ V},$	$V_{I} = 2.7 \text{ V}$			20			20	μΑ
I _{IL}	$V_{CC} = 5.5 \text{ V},$	$V_{I} = 0.5 V$			-1			-1	mA
I _{OZH}	V _{CC} = 5.5 V,	V _O = 2.7 V			50			50	μΑ
l _{OZL}	$V_{CC} = 5.5 \text{ V},$	V _O = 0.5 V			-50			-50	μΑ
los [‡]	$V_{CC} = 5.5 \text{ V},$	V _O = 0	-100		-225	-100		-225	mA
Іссн	$V_{CC} = 5.5 \text{ V},$	Outputs open		19	32		19	32	mA
I _{CCL}	$V_{CC} = 5.5 \text{ V},$	Outputs open		46	76		46	76	mA
I _{CCZ}	$V_{CC} = 5.5 \text{ V},$	Outputs open		6	8		6	8	mA

 $^{^{\}dagger}$ All typical values are at $V_{CC} = 5$ V, $T_A = 25$ °C.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature, C_L =50 pF (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	TO (OUTDUT)	V _{CC} = 5 V, T _A = 25°C			SN54B0	CT2240	SN74B0	UNIT	
	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t _{PLH}	^	V	0.5	3.4	4.8	0.5	6.3	0.5	5.7	
t _{PHL}	A	Y	0.5	2.8	4	0.5	4.6	0.5	4.4	ns
t _{PZH}	OF.	Υ	2.6	6.2	8.2	2.6	10.1	2.6	9.3	
t _{PZL}	ŌĒ		4.3	8.8	10.9	4.3	12.9	4.3	12.4	ns
t _{PHZ}	ŌĒ	V	2	5.3	7.1	2	9.2	2	8.7	20
t _{PLZ}	OE .	f	2.2	6.7	8.5	2.2	12.2	2.2	10.6	ns



[†] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

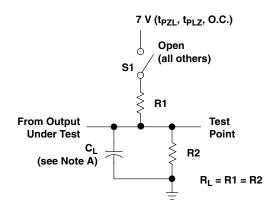
Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP

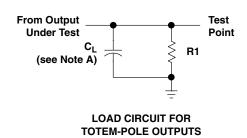
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

SN54BCT2240, SN74BCT2240 OCTAL BUFFERS AND LINE/MOS DRIVERS WITH 3-STATE OUTPUTS

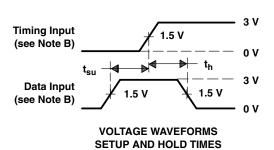
SCBS030E - SEPTEMBER 1988 - REVISED MARCH 2003

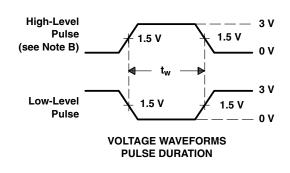
PARAMETER MEASUREMENT INFORMATION

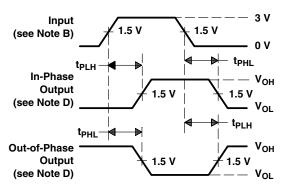


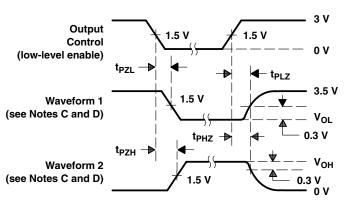


LOAD CIRCUIT FOR **3-STATE AND OPEN-COLLECTOR OUTPUTS**









VOLTAGE WAVEFORMS PROPAGATION DELAY TIMES (see Note D)

VOLTAGE WAVEFORMS ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS

NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $t_r = t_f \leq 2.5$ ns, duty cycle = 50%.
- C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- The outputs are measured one at a time with one transition per measurement.
- E. When measuring propagation delay times of 3-state outputs, switch S1 is open.
- F. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms





Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

17-Dec-2015

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing		Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9093901M2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 9093901M2A SNJ54BCT 2240FK	Samples
5962-9093901MRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9093901MR A SNJ54BCT2240J	Samples
SN74BCT2240DBLE	OBSOLET	E SSOP	DB	20		TBD	Call TI	Call TI	0 to 70		
SNJ54BCT2240FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962- 9093901M2A SNJ54BCT 2240FK	Samples
SNJ54BCT2240J	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9093901MR A SNJ54BCT2240J	Samples

(1) The marketing status values are defined as follows: ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Ti's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

Addendum-Page 1



Distributor of Texas Instruments: Excellent Integrated System LimitedDatasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

PACKAGE OPTION ADDENDUM

www.ti.com 17-Dec-2015

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "--" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information that way not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN54BCT2240, SN74BCT2240:

- Catalog: SN74BCT2240
- Military: SN54BCT2240

NOTE: Qualified Version Definitions:

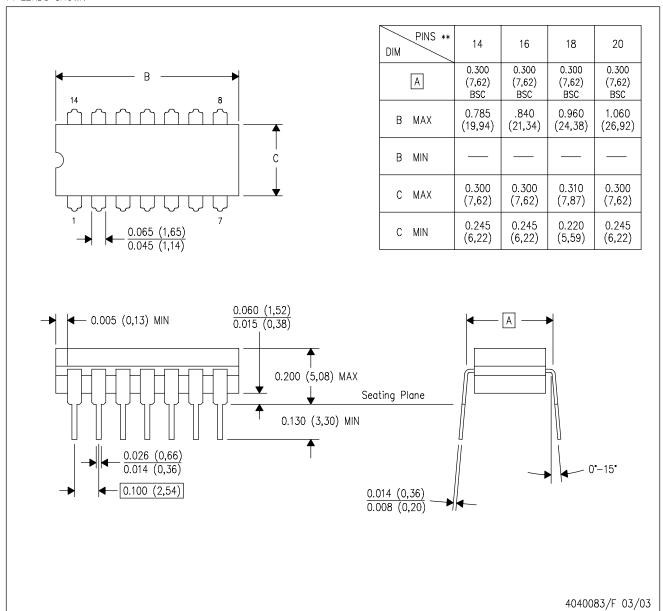
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



J (R-GDIP-T**)

CERAMIC DUAL IN-LINE PACKAGE

14 LEADS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

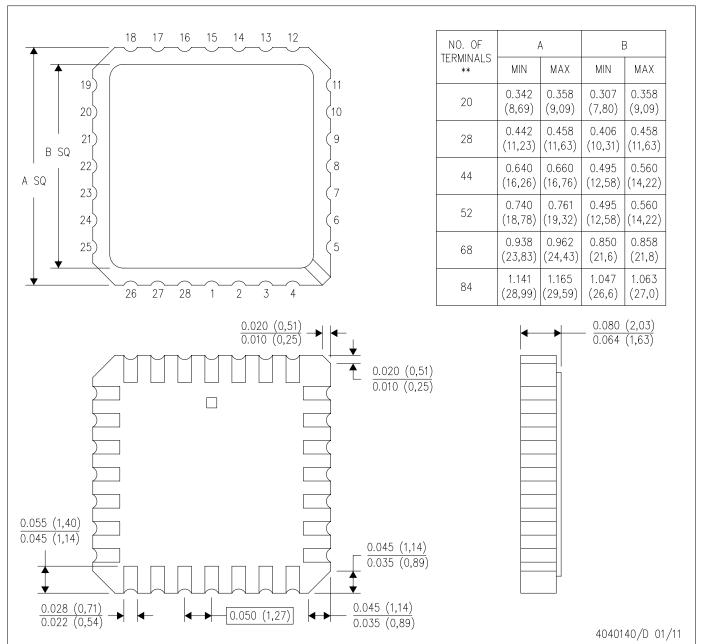
Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

MECHANICAL DATA

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. Falls within JEDEC MS-004





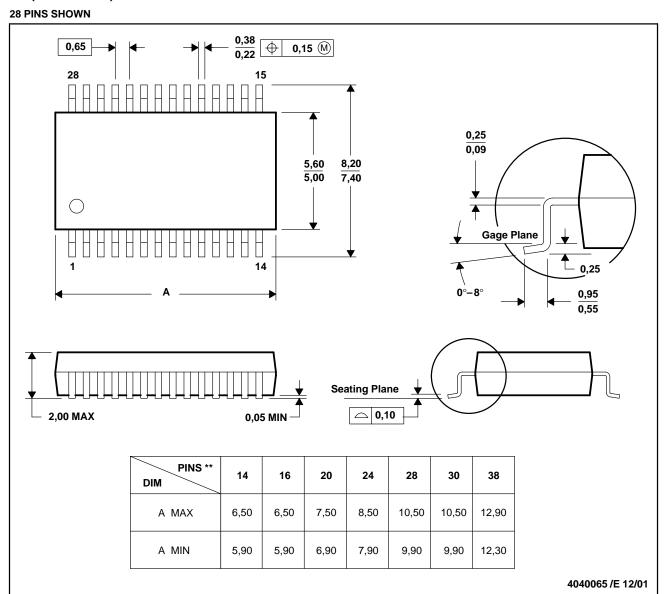
Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150





Distributor of Texas Instruments: Excellent Integrated System Limited Datasheet of SN74BCT2240DBR - IC INVERTER DUAL 4-INPUT 20SSOP

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have not been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive **Amplifiers** amplifier.ti.com Communications and Telecom www.ti.com/communications Computers and Peripherals **Data Converters** dataconverter.ti.com www.ti.com/computers **DLP® Products** Consumer Electronics www.ti.com/consumer-apps www.dlp.com DSP dsp.ti.com **Energy and Lighting** www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical

logic.ti.com Power Mgmt Space, Avionics and Defense www.ti.com/space-avionics-defense power.ti.com

Security

www.ti.com/security

Microcontrollers microcontroller.ti.com Video and Imaging www.ti.com/video

RFID www.ti-rfid.com

Products

Logic

OMAP Applications Processors TI E2E Community www.ti.com/omap e2e.ti.com

Wireless Connectivity www.ti.com/wirelessconnectivity

> Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2015, Texas Instruments Incorporated